

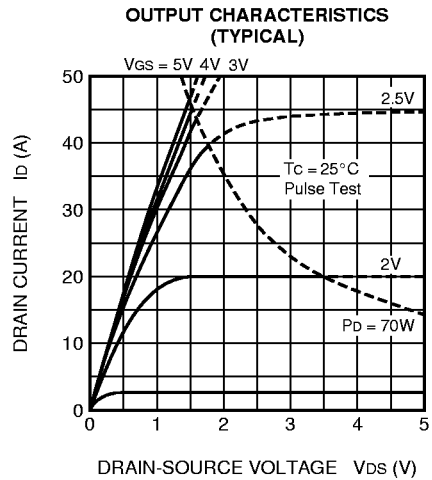
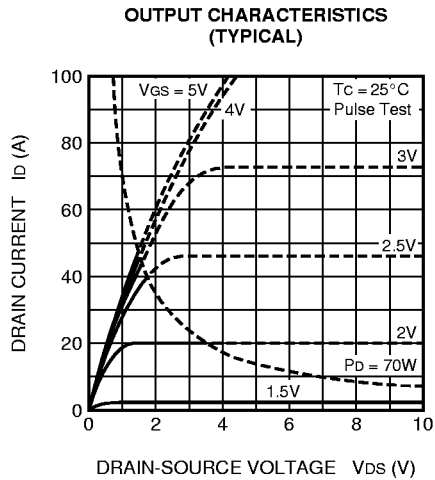
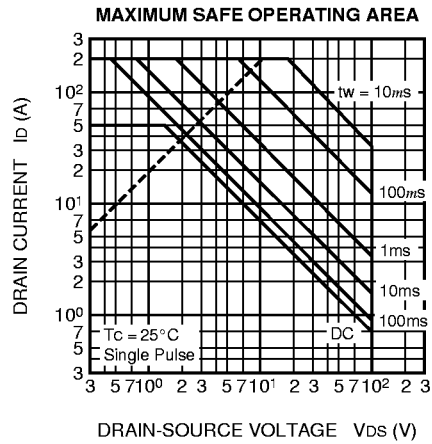
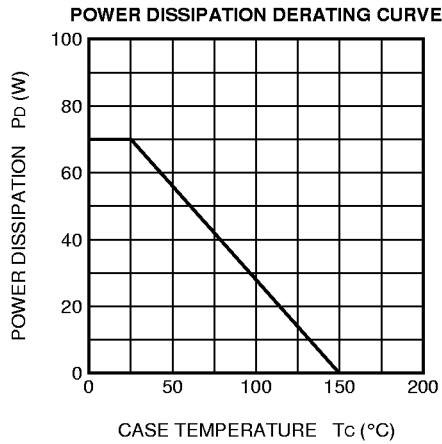
FS50SMH-2

HIGH-SPEED SWITCHING USE

ELECTRICAL CHARACTERISTICS (T_{ch} = 25°C)

Symbol	Parameter	Test conditions	Limits			Unit
			Min.	Typ.	Max.	
V _{(BR)DSS}	Drain-source breakdown voltage	I _D = 1mA, V _{GS} = 0V	100	—	—	V
I _{GSS}	Gate-source leakage current	V _{GS} = ±10V, V _{DS} = 0V	—	—	±0.1	μA
I _{DSS}	Drain-source leakage current	V _{DS} = 100V, V _{GS} = 0V	—	—	0.1	mA
V _{GS(th)}	Gate-source threshold voltage	I _D = 1mA, V _{DS} = 10V	0.6	0.9	1.2	V
r _{DS(ON)}	Drain-source on-state resistance	I _D = 25A, V _{GS} = 4V	—	38	52	mΩ
r _{DS(ON)}	Drain-source on-state resistance	I _D = 25A, V _{GS} = 2.5V	—	41	54	mΩ
V _{DS(ON)}	Drain-source on-state voltage	I _D = 25A, V _{GS} = 4V	—	0.95	1.30	V
y _{fs}	Forward transfer admittance	I _D = 25A, V _{DS} = 10V	—	54	—	S
C _{iss}	Input capacitance	V _{DS} = 10V, V _{GS} = 0V, f = 1MHz	—	4000	—	pF
C _{oss}	Output capacitance		—	420	—	pF
C _{rss}	Reverse transfer capacitance		—	210	—	pF
t _{d(on)}	Turn-on delay time	V _{DD} = 50V, I _D = 25A, V _{GS} = 4V, R _{GEN} = R _{GS} = 50Ω	—	55	—	ns
t _r	Rise time		—	190	—	ns
t _{d(off)}	Turn-off delay time		—	340	—	ns
t _f	Fall time		—	260	—	ns
V _{SD}	Source-drain voltage	I _S = 25A, V _{GS} = 0V	—	1.0	1.5	V
R _{th(ch-c)}	Thermal resistance	Channel to case	—	—	1.78	°C/W
t _{rr}	Reverse recovery time	I _S = 50A, dis/dt = -100A/μs	—	110	—	ns

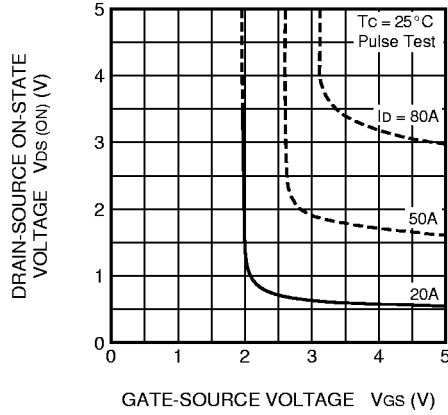
PERFORMANCE CURVES



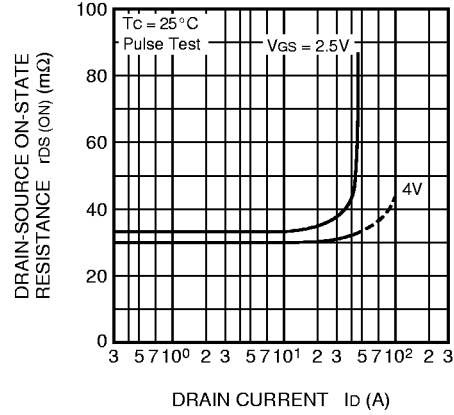
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HIGH-SPEED SWITCHING USE

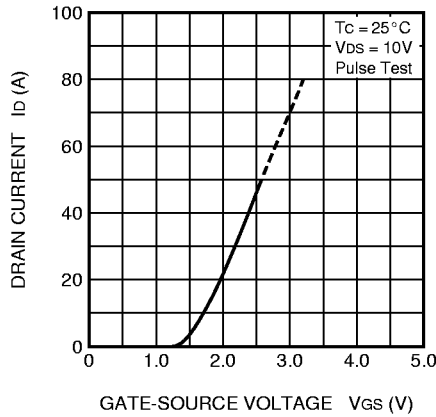
ON-STATE VOLTAGE VS. GATE-SOURCE VOLTAGE (TYPICAL)



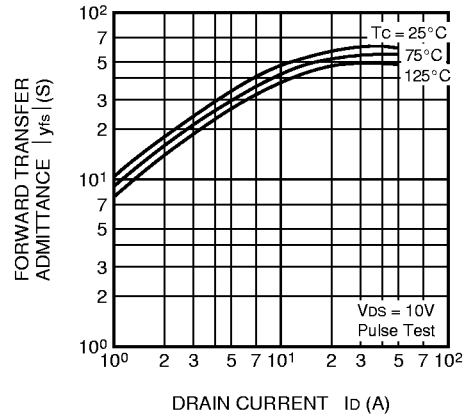
ON-STATE RESISTANCE VS. DRAIN CURRENT (TYPICAL)



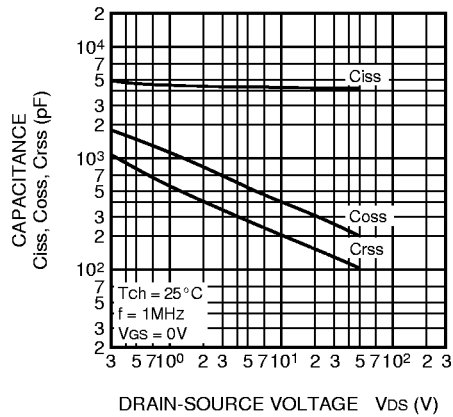
TRANSFER CHARACTERISTICS (TYPICAL)



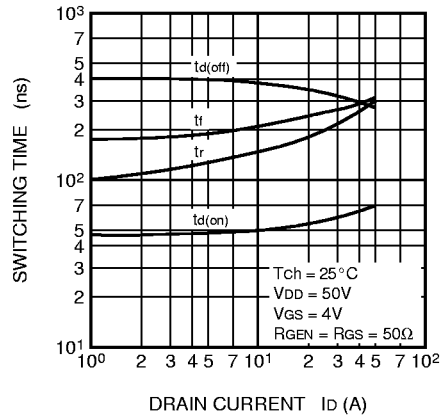
FORWARD TRANSFER ADMITTANCE VS. DRAIN CURRENT (TYPICAL)



CAPACITANCE VS. DRAIN-SOURCE VOLTAGE (TYPICAL)



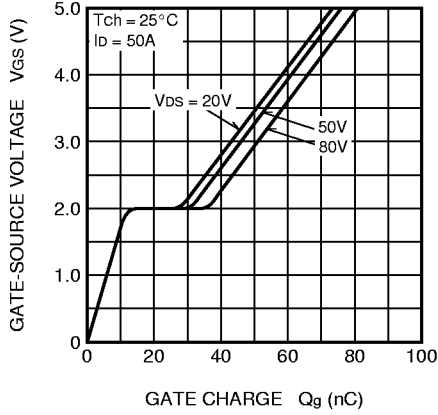
SWITCHING CHARACTERISTICS (TYPICAL)



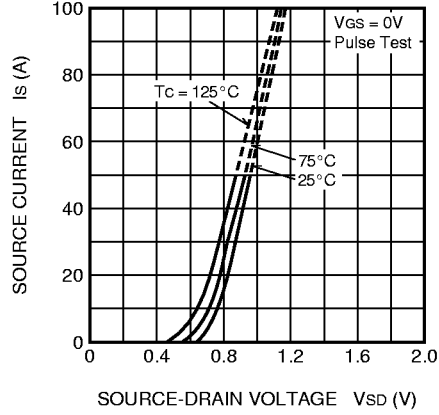
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HIGH-SPEED SWITCHING USE

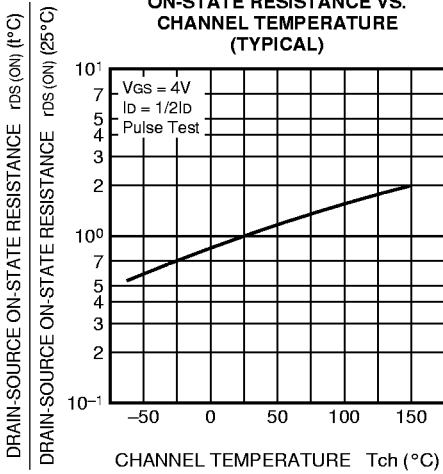
GATE-SOURCE VOLTAGE VS. GATE CHARGE (TYPICAL)



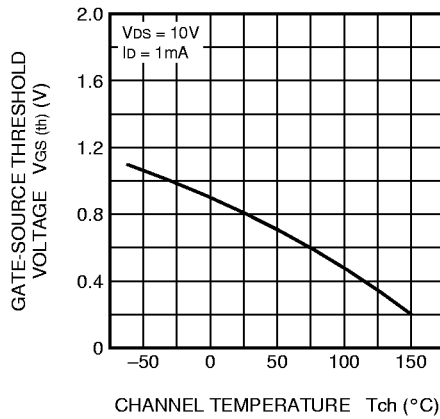
SOURCE-DRAIN DIODE FORWARD CHARACTERISTICS (TYPICAL)



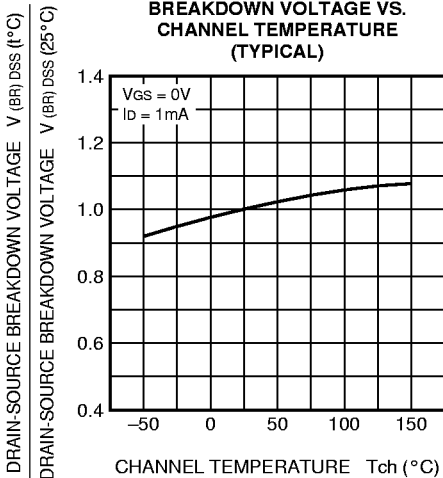
ON-STATE RESISTANCE VS. CHANNEL TEMPERATURE (TYPICAL)



THRESHOLD VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



BREAKDOWN VOLTAGE VS. CHANNEL TEMPERATURE (TYPICAL)



TRANSIENT THERMAL IMPEDANCE CHARACTERISTICS

